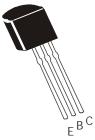


Continental Device India Limited An ISO/TS 16949, ISO 9001 and ISO 14001 Certified Company



NPN SILICON PLANAR EPITAXIAL TRANSISTORS



TO-92

MPSA42/ MPSA43

Plastic Package For Lead Free Parts, Device Part # will be Prefixed with "T"

High Voltage Transistors

ABSOLUTE MAXIMUM RATINGS

| DESCRIPTION | SYMBOL | MPSA42 | MPSA43 | UNITS |
|--|-----------------------------------|---------|--------------|-------|
| Collector Base Voltage | V _{CBO} | 300 | 200 | V |
| Collector Emitter Voltage | V _{CEO} | 300 | 200 | V |
| Emitter Base Voltage | V _{EBO} | 6. | 6.0 | |
| Collector Current Continuous | Ι _C | 50 | 500 | |
| Power Dissipation at T _a =25 ^o C | P _D | 62 | 625 | |
| Derate Above 25°C | | 5. | 5.0 | |
| Power Dissipation at T _c =25 ^o C | P _D | 1. | 1.5 | |
| Derate Above 25°C | | 1 | 12 | |
| Operating And Storage Junction Temperature Range | T _j , T _{stg} | - 55 to | - 55 to +150 | |

THERMAL CHARACTERISTICS

| Junction to Case | R _{th (j-c)} | 83.3 | °C/W |
|---------------------------------|-----------------------|------|------|
| Junction to Ambient in free air | R _{th (j-a)} | 200 | °C/W |

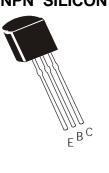
ELECTRICAL CHARACTERISTICS (T_a=25°C unless specified otherwise)

| DESCRIPTION | SYMBOL | TEST COND | ITION | MIN | MAX | UNITS |
|--------------------------------------|------------------------|--|-------------------|-----|-----|-------|
| Collector Emitter Voltage | V _{CEO} | I _C =1mA, I _B =0 | | | | |
| | | | MPSA42 | 300 | | V |
| | | | MPSA43 | 200 | | V |
| Collector Base Voltage | V _{CBO} | I _C =100μA, | I _E =0 | | | |
| | | | MPSA42 | 300 | | V |
| | | | MPSA43 | 200 | | V |
| Emitter Base Voltage | V _{EBO} | I _E =100μA, | I _C =0 | 6 | | V |
| Collector Cut Off Current | I _{CBO} | V _{CB} =200V, I _E =0, | MPSA42 | | 100 | nA |
| | | V _{CB} =160V, I _E =0, | MPSA43 | | 100 | nA |
| Emitter Cut Off Current | I _{EBO} | $V_{EB}=6V, I_{C}=0,$ | MPSA42 | | 100 | nA |
| | | V _{EB} =4V, I _C =0, | MPSA43 | | 100 | nA |
| DC Current Gain | *h _{FE} | V_{CE} =10V, I_{C} = | =1mA | 25 | | |
| | | V _{CE} =10V, I _C = | 10mA | 40 | | |
| | | V _{CE} =10V, I _C =30mA | | 40 | | |
| Collector Emitter Saturation Voltage | *V _{CE (sat)} | I _C =20mA, I _B = | =2mA | | | |
| | | | MPSA42 | | 0.5 | V |
| | | MPSA43 | | | 0.4 | V |
| Base Emitter Saturation Voltage | *V _{BE (sat)} | I _C =20mA, I _B =2mA | | | 0.9 | V |

*PulseTest: Pulse Width <300ms, Duty Cycle<2% MPSA42_43Rev_2 290606D

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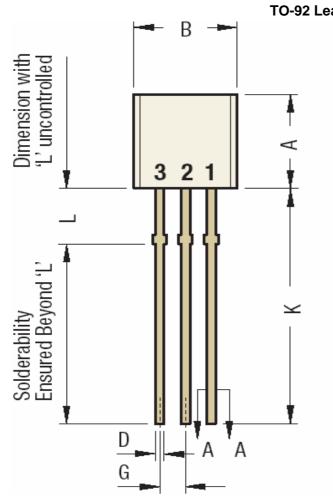
TO-92

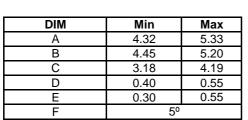
Plastic Package For Lead Free Parts, Device Part # will be Prefixed with "T"

ELECTRICAL CHARACTERISTICS (T_a=25°C unless specified otherwise)

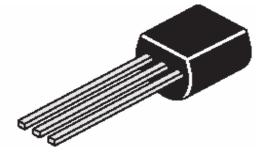
DYNAMIC CHARACTERISTICS

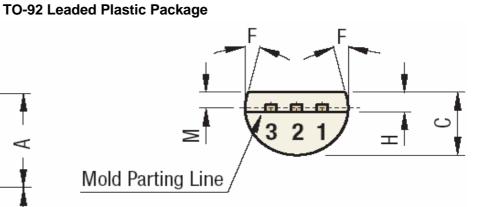
| DESCRIPTION | SYMBOL | TEST CONDITION | MIN | MAX | UNITS |
|--------------------------------|-----------------|--|-----|-----|-------|
| Current Gain Bandwidth Product | f _T | I _C =10mA, V _{CE} =20V, f=100MHz | 50 | | MHz |
| Collector Base Capacitance | C _{cb} | V_{CB} =20V, I_{E} =0, f=1MHz | | | |
| | | MPSA42 | | 3.0 | pF |
| | | MPSA43 | | 4.0 | pF |

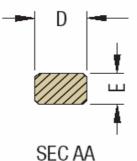




All Dimensions are in mm







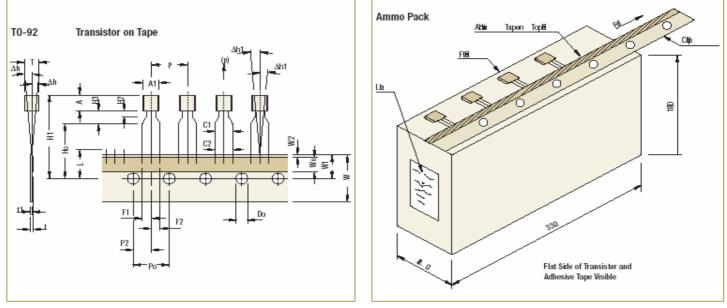
| DIM | Min | Max |
|-----|-------|-------|
| G | 1.14 | 1.40 |
| Н | 1.20 | 1.40 |
| K | 12.7 | |
| L | 1.982 | 2.082 |
| М | 1.03 | 1.20 |
| | | |

| Pin | 1 | Collector |
|-----|---|-----------|
| | | |

Pin 2 Base er

MPSA42/ MPSA43 **TO-92 Plastic Package**

For Lead Free Parts, Device Part # will be Prefixed with "T"



TO-92 Tape and Ammo Packaging

All Dimensions are in mm

| | | T0-92 | | |
|---|--------|-------|------|---|
| Item description | Symbol | Min | Nom | 1 |
| Body width | A1 | 4.45 | | Ī |
| Body height | A | 4.32 | | T |
| Body thickness | Т | 3.18 | | T |
| Pitch of component ^{Cr} | Р | | 12.7 | T |
| Feed hole pitch ^{§1} | Po | | 12.7 | T |
| Feed hole center to | | | | T |
| component centre§2 | P2 | | 6.35 | |
| Comp. alignment, Side view ^{§3} | Dh | | 0 | 1 |
| Comp. alignment, Front view ^{§3} | Dh1 | | 0 | 1 |
| Tape width ^{Cr} | W | | 18 | 1 |
| Hold down tape width ^{Cr} | Wo | | 6 | 1 |
| Hole position | W1 | | 9 | 1 |
| Hold-down tape position | W2 | 0.0 | | 1 |
| Lead wire clinch height | Но | | 16 | T |
| Component height | H1 | | | 1 |
| Length of snipped leads | L | | | 1 |
| Feed hole diameter ^{Cr} | Do | | 4 | 1 |
| Total tape thickness ^{§4} | t | | | 1 |
| Lead-to-lead distance ^{Cr} | F1, F2 | 2.4 | | 1 |
| Stand off | H2 | 0.45 | | 1 |
| Clinch height | H3 | | | 1 |
| Lead parallelismCr | C1-C2 | | | 1 |
| Pull-out force | (p) | 6N | | 1 |

All Dimensions are in mm

Tape Specifications

Tol

±1.0

 ± 0.3

±0.4

 ± 0.5

±0.2

+0.7 -0.5

±0.5

±0.2

Max

5.20

5.33

4.19

1.0

1.3

0.7

24.0 11.0

> 1.2 2.7

1.45

3.0

0.22

Taping Specification

- · Maximum alignment deviation between leads not to be greater than 0.20 mm.
- Maximum non-cumulative variation ٠ between tape feed holes shall not exceed 1 mm in 20 pitches.
- · Hold down tape not to exceed beyond the edge(s) carrier tape and there shall be no exposure of adhesive.
- . No more than 3 consecutive missing components is permitted.
- A tape trailer, having at least three ٠ feed holes is required after the last component.
- Splices shall not interfere with the • sprocket feed holes.

§1 Cumulative pitch error 1.0 mm/20 pitch.

- §2 To be measured at bottom of clinch.
- §3 At top of body.
- §4 t1 = 0.3 0.6 mm
- Cr Critical Dimension.

Packaging Information

T & A: Tape and Ammo Pack; T & R: Tape and Red; Bulk: Loose in Poly bags; Tube: Tube and Ammo Pack; k: 1.000

| Package/Case | | Std. Packing | Packing Inner Carton | | | Outer Carton | | |
|--------------|----------------|--------------|----------------------|----------------|--------------|--------------|----------------|---------------------|
| Туре | Packaging Type | Qty Qty | | Size L x W x H | Gross Weight | Qtv | Size L x W x H | Gross Weight |
| Туре | QLy | QLY | (cm) | (Kg) | QLY | (cm) | (Kg) | |
| TO-92 | Bulk | 1,000 | 5K | 19x19x8 | 1.10 | 80K | 43x40x35 | 20.0 |
| 10-92 | T&A | 2,000 | 2K | 32x4.5x20 | 0.70 | 40K | 43x40x35 | 15.20 |

Component Disposal Instructions

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Customer Notes

Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).CDIL strives for continuous improvement and reserves the right to change the specifications of its products without prior notice.



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